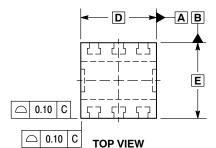
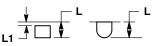
MECHANICAL CASE OUTLINE



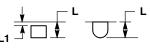
CUDFN6 2x2, 0.65P CASE 505AK **ISSUE 0**

DATE 08 JAN 2014





DETAIL A ALTERNATE TERMINAL CONSTRUCTIONS





DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

Y 14.5M, 1994.

2 CONTROLLING DIMENSION: MILLIMETERS.

3. DIMENSION 6 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.25MM FROM

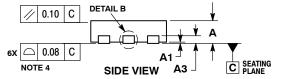
NOTES:

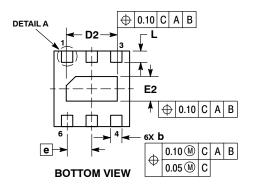


DETAIL B ALTERNATE CONSTRUCTIONS

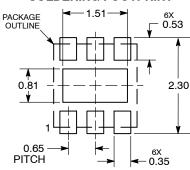


0.15





RECOMMENDED SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	CUDFN6 2X2, 0.65P		PAGE 1 OF 1

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